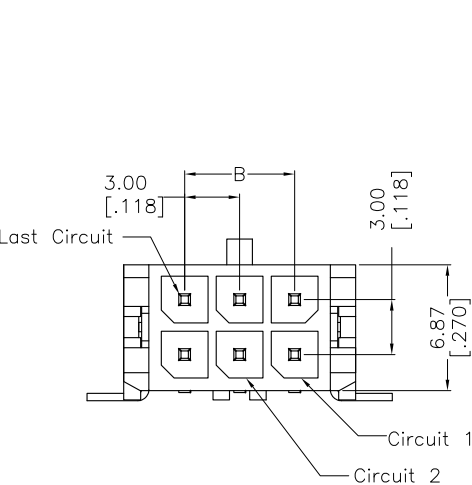


CRIMP-CON SMT BENT ADDITIONAL SOLDERING PADS,
Series 300, 3.00 x 3.00mm, 2 rows, 2 - 24 Positions, black

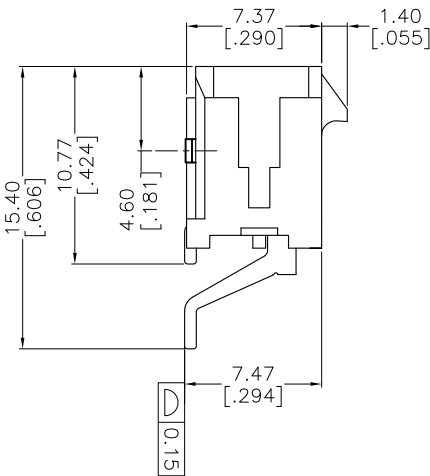
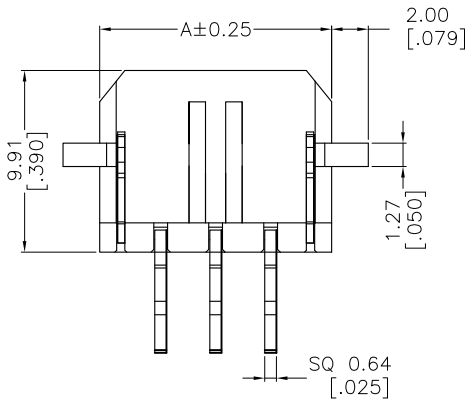
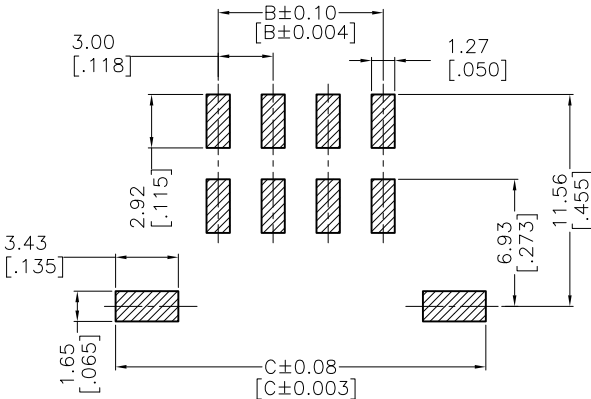


NOTES:
Current Rating: 5,0 AMP
Contact Resistance: 10mΩ max.
Withstand Voltage: 1000V AC/Minute
Insulation Resistance: 1000MΩ min.
Operation Temperature: -25°C to +85°C

Contact Material: Copper Alloy
Contact Plating: Au/Sn over Ni



RECOMMENDED PCB LAYOUT
TOLERANCE IS ±0.05



OPERATION	
X.X	±0.40
X.XX	±0.25
X.XXX	±0.15
Angle	± 3°
DIM	TOL

CLB 300 - 2 XX - B X C

Pitch	Material	No. of rows	Positions per row	Plating	Color	Packaging	Option
3,00mm	- = LCP UL94V-0		01 02 03 04 05 06 07 08 09 10 11 12		B = Black	0 = PE-Bag J = Tray R = T&R T = Tube	
No. of Position		Dimension [mm]					
		A	B	C			
02		6,65	n/a	11,20			
04		9,65	3,00	14,20			
06		12,65	6,00	17,20			
08		15,65	9,00	20,20			
10		18,65	12,00	23,20			
12		21,65	15,00	26,20			
14		24,65	18,00	29,20			
16		27,65	21,00	32,20			
18		30,65	24,00	35,20			
20		33,65	27,00	38,20			
22		36,65	30,00	41,20			
24		39,65	33,00	44,20			

1	26.08.2021	issued	PER
REV	DATE	NOTE	NAME